



EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

Product Type:	Evaluation Kit
Model Number(s):	EVM430-CAPMINI

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

EMC Directive 2014/30/EU

The following harmonized standards and technical specifications have been applied:

EN 61326-1:2013

Notified Body:

Notified Body:	Intertek Testing & Certification LTD
Notified Body Number	0359
Reference number of the certificate of notified body	0003594

Technical Compliance File Held by:

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

Name:	Darrin Malpass
Address:	13905 University Drive, Sugarland, TX 77479

SUGARLAND, TX

Place of issue

08-13-18

Date of issue

Darrin J. Malpass

Signature of Authorized Person

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